# Old Company Name in Catalogs and Other Documents

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# **HAT2279H**

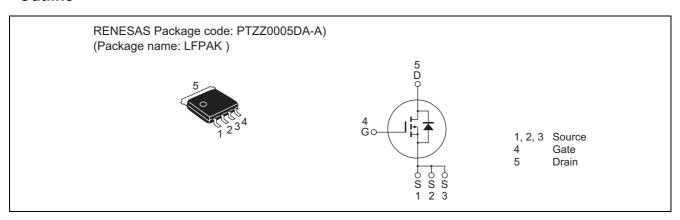
# Silicon N Channel Power MOS FET Power Switching

REJ03G1464-0200 Rev.2.00 Jul 05, 2006

#### **Features**

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance
  - $R_{DS(on)} = 9.5 \text{ m}\Omega \text{ typ. (at } V_{GS} = 10 \text{ V})$
- Lead Free

#### **Outline**



## **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	80	V
Gate to source voltage	$V_{GSS}$	±20	V
Drain current	I <sub>D</sub>	30	Α
Drain peak current	I <sub>D(pulse)</sub> Note1	120	Α
Body-drain diode reverse drain current	I <sub>DR</sub>	30	Α
Avalanche current	I <sub>AP</sub> Note 2	25	Α
Avalanche energy	E <sub>AR</sub> Note 2	83	mJ
Channel dissipation	Pch Note3	25	W
Channel to Case Thermal Resistance	θch-C	5	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	−55 to +150	°C

Notes: 1. PW ≤ 10 ∞s, duty cycle ≤ 1%

2. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$ 

3.  $Tc = 25^{\circ}C$ 

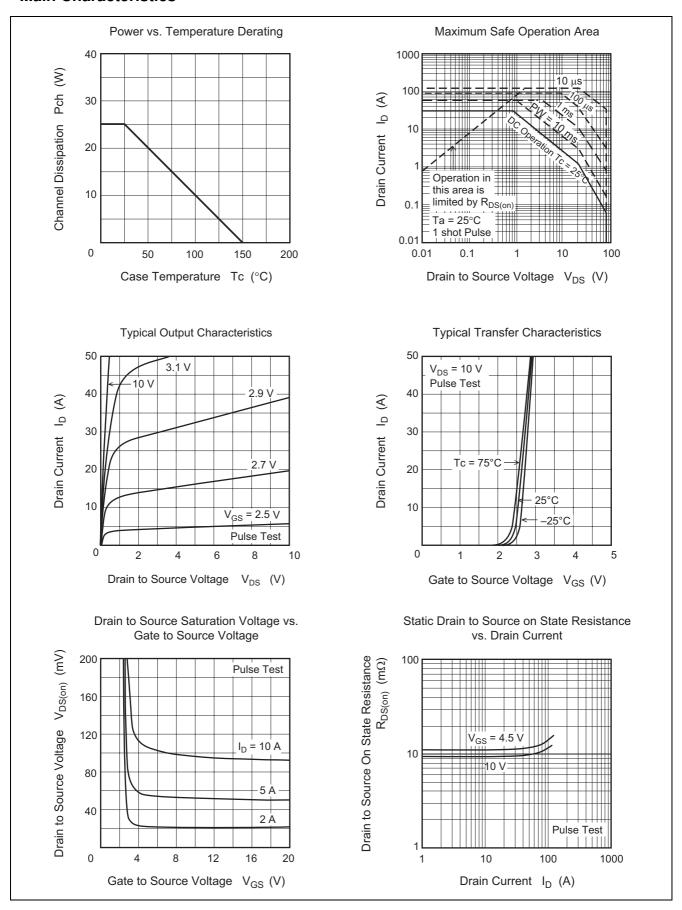
# **Electrical Characteristics**

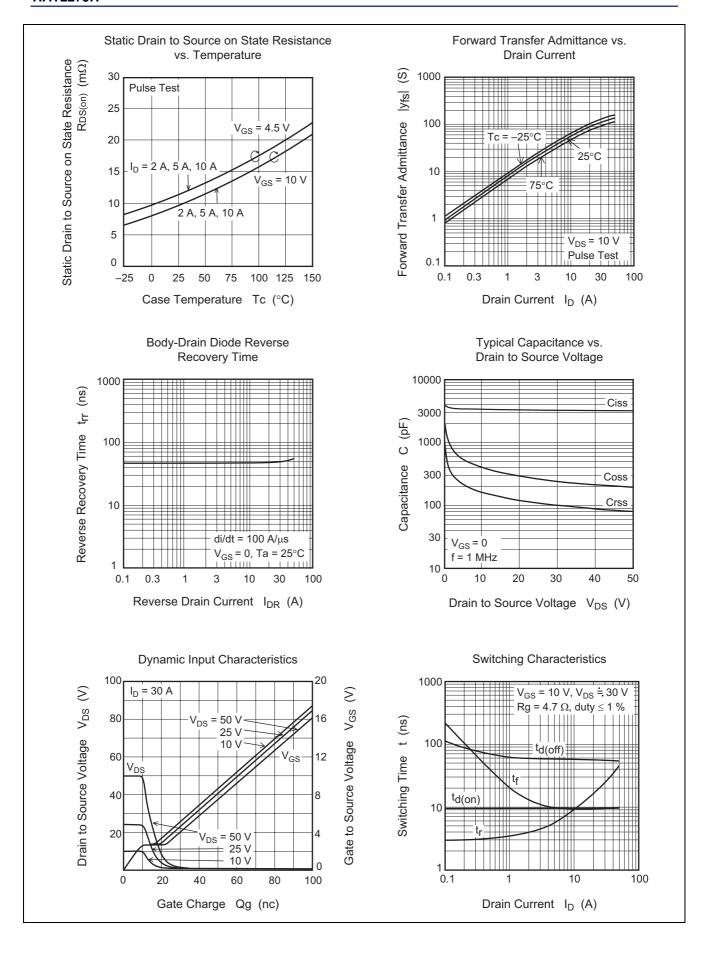
 $(Ta = 25^{\circ}C)$ 

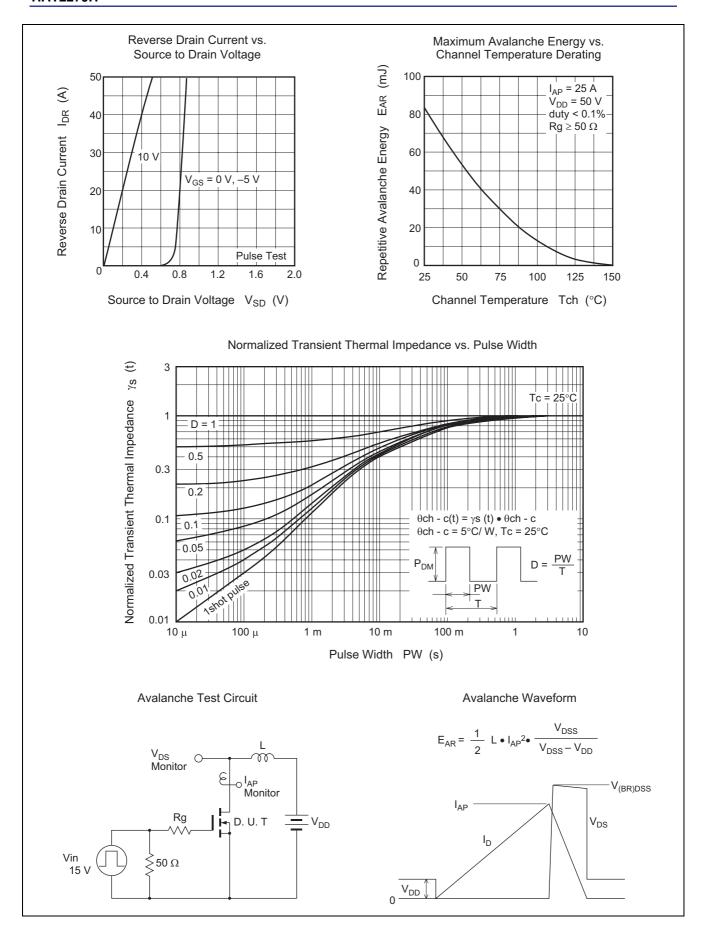
Item	Symbol	Min	Тур	Max	Unit	Test Conditions	
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	80	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Gate to source leak current	I <sub>GSS</sub>	_	_	±0.5	∞A	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$	
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	1	∞A	$V_{DS} = 80 \text{ V}, V_{GS} = 0$	
Gate to source cutoff voltage	$V_{GS(off)}$	0.8		2.3	٧	$V_{DS} = 10 \text{ V}, \text{ I }_{D} = 1 \text{ mA}$	
Static drain to source on state	R <sub>DS(on)</sub>	_	9.5	12	mΩ	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$	
resistance	R <sub>DS(on)</sub>	_	11	15	mΩ	$I_D = 15 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$	
Forward transfer admittance	y <sub>fs</sub>	42	70		S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$	
Input capacitance	Ciss	_	3520		pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$	
Output capacitance	Coss	_	410		pF	f = 1 MHz	
Reverse transfer capacitance	Crss	_	160	_	pF		
Gate Resistance	Rg	_	0.5	_	Ω		
Total gate charge	Qg	_	60	_	nC	$V_{DD} = 25 \text{ V}, V_{GS} = 10 \text{ V},$	
Gate to source charge	Qgs	_	9.5	_	nC	$I_D = 30 A$	
Gate to drain charge	Qgd	_	9.0	_	nC		
Turn-on delay time	$t_{d(on)}$	_	9.5	_	ns	$V_{GS} = 10 \text{ V}, I_D = 15 \text{ A},$	
Rise time	t <sub>r</sub>	_	14.5	_	ns	$V_{DD}\cong 30~V,~R_L=2~\Omega,$	
Turn-off delay time	$t_{d(off)}$	_	56	_	ns	$Rg = 4.7 \Omega$	
Fall time	t <sub>f</sub>	_	9.5	_	ns	1	
Body-drain diode forward voltage	$V_{DF}$		0.83	1.08	V	$IF = 30 A$ , $V_{GS} = 0$ $Note 4$	
Body-drain diode reverse recovery	t <sub>rr</sub>		50	_	ns	IF = 30 A, V <sub>GS</sub> = 0	
time						$di_F/dt = 100 \text{ A/} \propto \text{s}$	

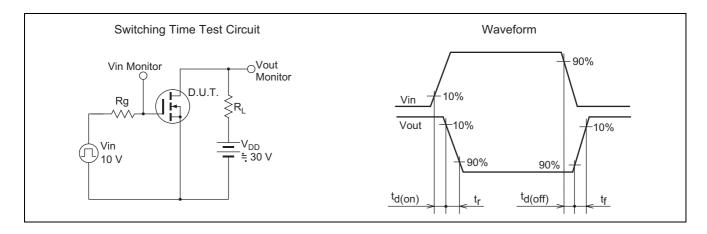
Notes: 4. Pulse test

### **Main Characteristics**

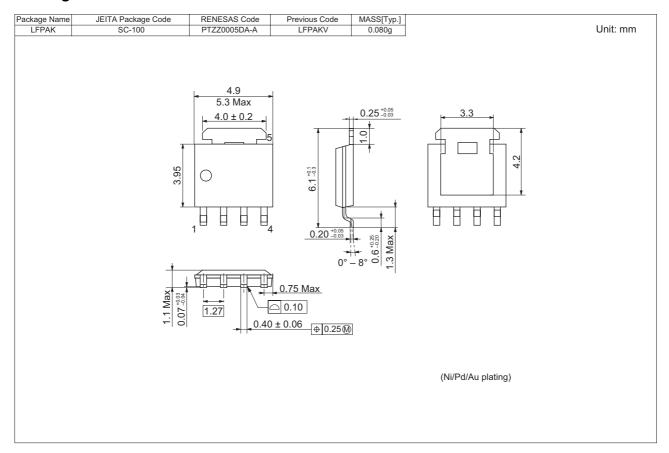








# **Package Dimensions**



# **Ordering Information**

Part Name	Quantity	Shipping Container		
HAT2279H-EL-E	2500 pcs	Taping		

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